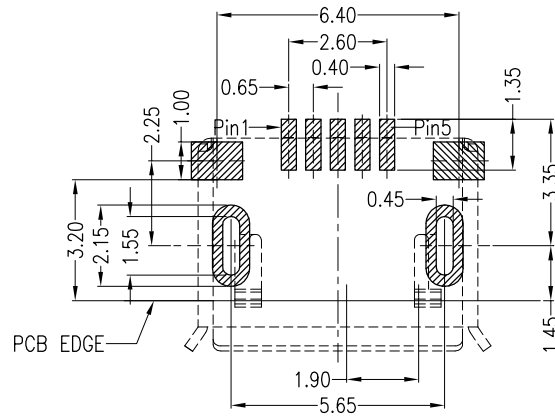
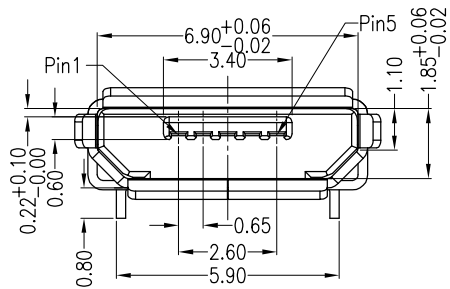
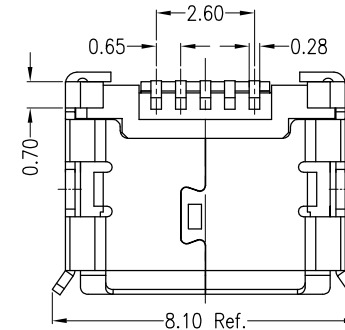
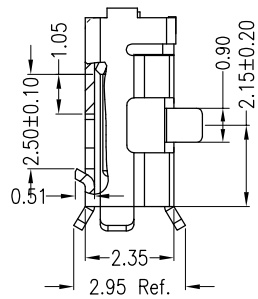
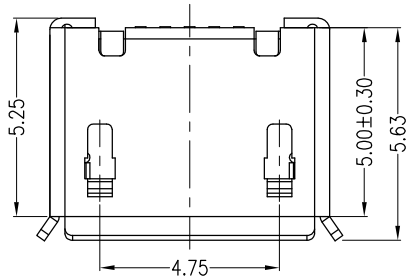
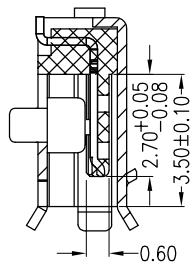
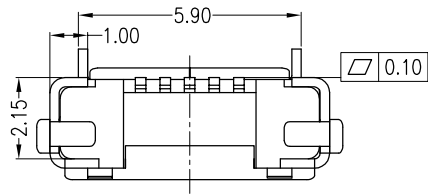


REV.	ECN NO	LOCATIONS	DESCRIPTION	DATE



RECOMMENDED PCB LAYOUT PCB图仅供参考

Note:

1.Material:

- 1.1 Housing: High temperature thermoplastic with g.f,UL94v-0
- 1.2 Contact: copper alloy,t=0.20mm
- 1.3 Shell: copper alloy,t=0.25mm

2.Specification:

- 2.1 Current rating:1,5PIN 1.8A Max/2,3,4PIN 1A Max.
- 2.2 Dielectric withstanding voltage: 100 V(ac) for 1 min.
- 2.3 Contact resistance: 30 mΩ Max.
- 2.4 Insulation resistance: 100 MΩ Min.
- 2.5 Total mating force: 3.57 Kgf Max.
- 2.6 Total unmating force: 1.0 Kgf Min.
- 2.7 Temperature range: -30°C~80°C

外壳材质
1:CB80R-H
7:SUS304R-1/2H

外壳电镀

- 1:NEUJ'
- 2:雾150J'
- 3:NAuAu' (脚)
- 4:AuAu'

端子电镀 01:AuAu' ;02:Au1.5J' ;03:AuAu'
05:AuAu' ;10:Au10J' ;15:Au15J' ;30:Au30J'

主体颜色 B:黑色

主体材质 1:LP

端子材质 4:CS191R-BH

PART NO: USB-F06505-SC085		MATERIAL: SEE NOTE	
MODEL NO: XX		FINISH: SEE NOTE	
UNIT: MM	SIZE: A4	COLOR: SEE NOTE	
TOLERANCE UNSPECIFIED		DR: LIU MIAO	
.x	0.15	CHK: SIMON	
.xx	0.10	APP: DAVID	
.xxx	0.05		
Ang.	1°		

WFDCONN 深圳市旺富达电子有限公司
SHEN ZHEN WFD ELECTRONICS CO., LTD

TITLE:
Micro usb 5s B Type 有焊脚插板5.9无柱

DWG NO: A036

REV: A

SCALE: 5:1

DATE: 2012.05.21

